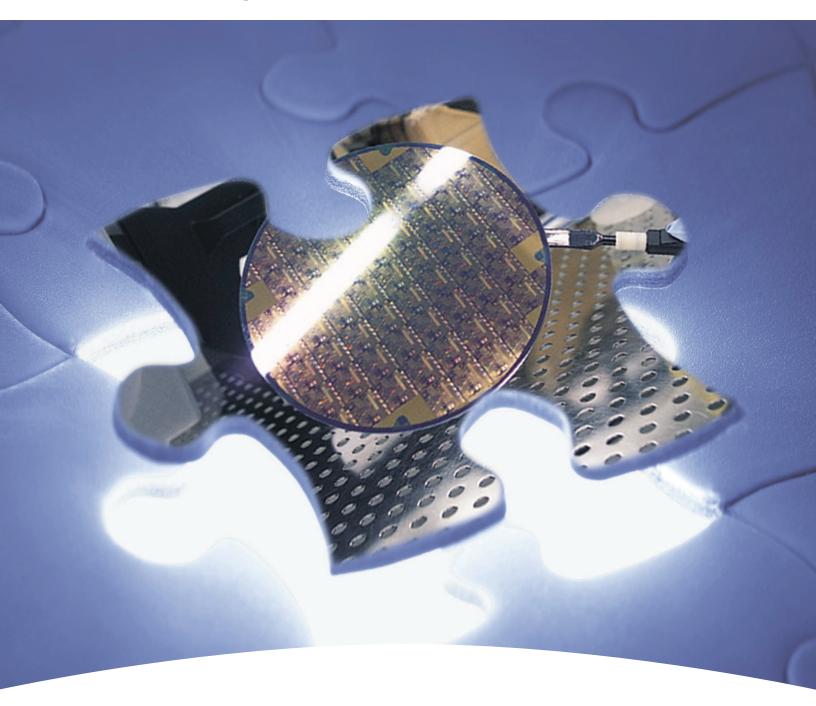
Electronic Polymers

Honeywell



Honeywell ACCUGLASS® P-TTY Spin-on Glass

Honeywell **ACCUGLASS® P-TTY Spin-on** Glass

PMD-BPSG PLANARIZATION

BENEFITS

- Industry proven performance and broad acceptance in subtractive aluminum processing
- Phosphorus stability up to 900°C
- · Thickness variation within a wafer of less than 2%
- P-112Ls has similar etch properties as BPSG

OVERVIEW

The ACCUGLASS P-TTY Spin-on Glass (SOG) Series ($\kappa = 4.1-4.3$) is a family of phosphosilicate polymers used for metal and poly planarization, overcoat passivation and non-etchback interlayer dielectric in the manufacture of integrated circuits. The ACCUGLASS P-TTY series also provides Na+ gettering ability similar to P-doped CVD oxides.

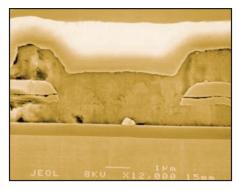
The ACCUGLASS P-TTY series contains 2wt% (P-112A), 2.7wt% (P-112LS) and 4wt% (P-114A) phosphorous bonded to O atoms in the Si-O backbone. The specific formulation results in a stable dielectric constant, <2% within wafer uniformity and can be densified at temperatures up to 700-900°C with no significant loss of phosphorous.

Thin films of ACCUGLASS P-TTY are applied using a commercial coater and cured in a vertical or horizontal furnace to thicknesses up to 1000Å (single coat) and 2000Å (double coat). Typically, two coats at ~1,000Å each are applied with hot plate bakes in between coats to achieve optimum planarization.

APPLICATIONS

- PMD-BPSG Planarization
- Overcoat Passivation
- ILD Planarization
- Available in both Etchback and Non-Etchback

Accuglass P-TTY is suitable for metal and poly planarization, partial and nonetchback applications in a CVD/SOG/CVD sandwich structure. ACCUGLASS P-TTY can also be used for overcoat passivation.



CVD/P-11 2LS/CVD sandwich structure. (SEM courtesy of ASMC)

P-TTY Spin Speed Curve P-112A

Thickness Range
700Å – 1,230Å
930Å – 1,420Å
835Å – 1,315Å

Film Properties Post Cure

FEATURES

Thickness

P-112LS Dielectric Constant @ 1 MHz: 4.2 P-112A Dielectric Constant @ 1 MHz: 4.1 P-114A Dielectric Constant @ 1 MHz: 4.3

Tensile Stress: 100 MPa Refractive Index @ 633 nm: 1.44 Coeff. of Thermal Expansion: 1X10-6K-1

Thickness 1600 1400 1200 1000 1000 800 1600 600 400

Spin Speed (rpm)

4000

3000



⋖

Film

200 Cured

Honeywell Electronic Materials

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Material Properties

P-112A Shelf Life @ 4°C: 6 months P-112LS Shelf Life @ 4°C: 6 months P-114A Shelf Life @ 4°C: 6 months

Bottle sizes available:

125ml, 250ml, 500ml, 1L, 2L, 4L

